



SYMBOL	MILLIMETERS		
	MIN.	NOM.	MAX.
A	--	--	1.19
A ₁	0.05	0.10	0.15
A ₂	0.79	--	1.04
B	0.18	--	0.30
C	0.10	--	0.20
D	6.40	6.50	6.60
E	4.29	4.39	4.47
e	0.65 BSC		
H	6.20	6.40	6.60
L	0.50	0.60	0.75
α	0°	5°	8°

NOTES:

- ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1982.
- DIMENSION "D" DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION SHALL NOT EXCEED 0.15mm PER SIDE
- DIMENSION "E" DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION SHALL NOT EXCEED 0.25mm PER SIDE
- EJECTOR PIN MARK IS A ROUND IMPRESSION MADE BY MACHINE DURING ASSEMBLY PROCESS
- LEAD FINISH: VO20 - 85/15 (Sn/Pb)
VOG20 - 100% Matte Sn
- CONFORMS TO JEDEC MO-153-AC

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Revision History

The following table shows the revision history for this document.

Date	Version	Description of Revisions
12/12/08	1.3	Revised the dimensions from inches to millimeters.
03/12/12	1.4	Changed the term <i>ejector pin</i> to <i>ejector pin mark</i> . Added note 4 to describe what the ejector pin mark is. Updated copyright and trademark notice and Notice of Disclaimer .

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